

BFR380L3

Linear Low Noise Silicon Bipolar RF Transistor

- High current capability and low noise figure for wide dynamic range
- Collector design supports supply voltage up to 5V
- Ideal for low phase noise oscillators up to 3.5 GHz
- Low noise figure 1.1 dB at 1.8 GHz
- Pb-free (RoHS compliant) and halogen-free thin small leadless package
- Qualification report according to AEC-Q101 available



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package	
BFR380L3	FC	1 = B	2 = E	3 = C	TSLP-3-1	

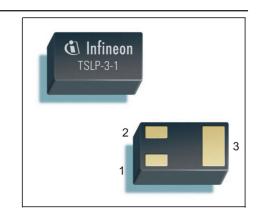
Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}	6	V
Collector-emitter voltage	V _{CES}	15	
Collector-base voltage	V _{CBO}	15	
Emitter-base voltage	V _{EBO}	2	
Collector current	I _C	80	mA
Base current	I _B	14	
Total power dissipation ¹⁾	P _{tot}	380	mW
<i>T</i> _S ≤ 96°C			
Junction temperature		150	°C
Storage temperature	T _{Stg}	-55 150	
Thermal Resistance			•

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	140	K/W

 ${}^{1}T_{S}$ is measured on the collector lead at the soldering point to the pcb

²For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)





Parameter	Symbol	Values		Unit	
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V _{(BR)CEO}	6	9	-	V
I _C = 1 mA, I _B = 0					
Collector-emitter cutoff current	I _{CES}				nA
$V_{\rm CE}$ = 5 V, $V_{\rm BE}$ = 0		-	1	30	
$V_{\rm CE}$ = 15 V, $V_{\rm BE}$ = 0		-	-	1000	
Collector-base cutoff current	I _{CBO}	-	-	30	
$V_{\rm CB} = 5 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	10	500	
$V_{\rm EB} = 1 \text{V}, I_{\rm C} = 0$					
DC current gain	h _{FE}	90	120	160	-
$I_{\rm C}$ = 40 mA, $V_{\rm CE}$ = 3 V, pulse measured					

Electrical Characteristics at T_A = 25 °C, unless otherwise specified



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)	I			
Transition frequency	f _T	11	14	-	GHz
<i>I</i> _C = 40 mA, <i>V</i> _{CE} = 3 V, <i>f</i> = 1 GHz					
Collector-base capacitance	C _{cb}	-	0.45	0.8	pF
$V_{\rm CB}$ = 5 V, <i>f</i> = 1 MHz, $V_{\rm BE}$ = 0 ,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.18	-	
$V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	1	-	
V _{EB} = 0.5 V, <i>f</i> = 1 MHz, V _{CB} = 0 ,					
collector grounded					
Minimum noise figure	NF _{min}	0.5	1.1	2.1	dB
$I_{\rm C}$ = 8 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
<i>f</i> = 1.8 GHz					
Power gain, maximum available ¹⁾	G _{ma}				
$I_{\rm C}$ = 40 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,					
<i>f</i> = 1.8 GHz		11.5	14	16.5	
<i>f</i> = 3 GHz		7.5	10	12.5	
Transducer gain	S _{21e} ²				dB
$I_{\rm C}$ = 40 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
<i>f</i> = 1.8 GHz		9.5	11.5	13.5	
<i>f</i> = 3 GHz		5.5	7.5	9.5	
Third order intercept point at output ²⁾	IP3	-	29.5	-	dBm
V _{CE} = 3 V, <i>I</i> _C = 40 mA, <i>f</i> = 1.8 GHz,					
$Z_{\rm S} = Z_{\rm L} = 50\Omega$					
1dB compression point at output	P _{-1dB}				1
<i>I</i> _C = 40 mA, <i>V</i> _{CE} = 3V, <i>f</i> = 1.8 GHz					
$Z_{\rm S} = Z_{\rm L} = 50\Omega$		-	16	-	
$Z_{\rm S} = Z_{\rm Sopt,} \ Z_{\rm L} = Z_{\rm Lopt}$		-	19.5	-	

Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

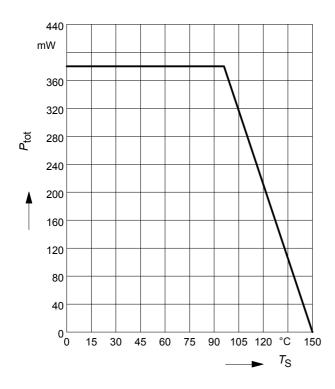
 ${}^{1}G_{\rm ma} = |S_{21e} / S_{12e}| \ (k - (k^2 - 1)^{1/2})$

²IP3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 500 from 0.1 MHz to 6 CHz

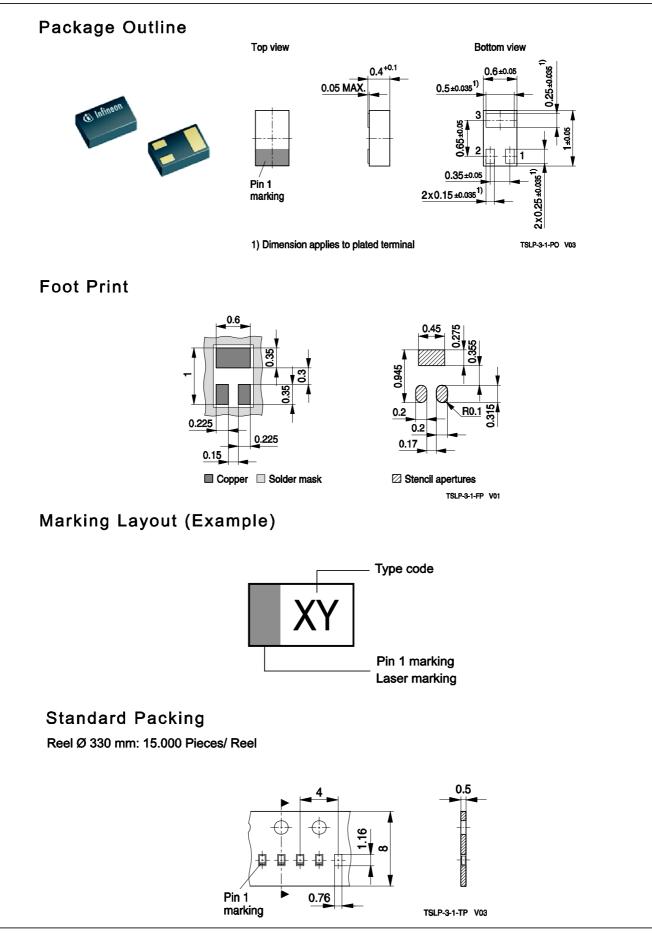
Termination used for this measurement is 50 Ω from 0.1 MHz to 6 GHz



Total power dissipation $P_{tot} = f(T_S)$











Edition 2009-11-16

Published by Infineon Technologies AG 81726 Munich, Germany

© 2009 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<<u>www.infineon.com</u>>).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.